

# NCE85H35TC

### NCE N-Channel Enhancement Mode Power MOSFET

### **Description**

The NCE85H35TC uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in automotive applications and a wide variety of other applications.

### **General Features**

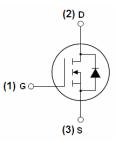
- V<sub>DSS</sub> =85V,I<sub>D</sub> =350A
  - $R_{DS(ON)} < 2.4 m\Omega \text{ @ } V_{GS}\text{=}10V \quad (\text{Typ: } 1.8 \text{ m}\Omega)$
- Good stability and uniformity with high E<sub>AS</sub>
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

### **Application**

- Automotive applications
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-247 top view

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE85H35TC	NCE85H35TC	TO-247	-	-	-

### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDSS	85	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	350	Α
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	247	Α
Pulsed Drain Current	I <sub>DM</sub>	1280	Α
Maximum Power Dissipation	P <sub>D</sub>	460	W
Derating factor		3.07	W/℃
Single pulse avalanche energy (Note 3)	E <sub>AS</sub>	3500	mJ
Operating Junction and Storage Temperature Range	$T_{J}$ , $T_{STG}$	-55 To 175	$^{\circ}$



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# NCE85H35TC

## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 1)	$R_{ heta JC}$	0.33	°C/W	
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## Electrical Characteristics (T<sub>C</sub>=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	85	90	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =85V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±200	nA
On Characteristics	·					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}$ = $V_{GS}$ , $I_D$ =250 $\mu$ A	2.5	3.6	4.5	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =40A	-	1.8	2.4	mΩ
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =20A	45	-	-	S
Dynamic Characteristics			•			•
Input Capacitance	C <sub>lss</sub>	\/ -25\/\/ -0\/	-	16000	-	PF
Output Capacitance	Coss	$V_{DS}$ =25V, $V_{GS}$ =0V, F=1.0MHz	-	1352	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVIH2	-	1061	-	PF
Switching Characteristics	·					
Turn-on Delay Time	t <sub>d(on)</sub>	)/ 00\/ L 40A	-	43	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =38V, $I_{D}$ =40A $V_{GS}$ =10V, $R_{GEN}$ =1.2 $\Omega$	-	220	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	(Note2)	-	170	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	260	-	nS
Total Gate Charge	Qg	\/ -20\/ I -20A	-	469	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =30V, $I_{D}$ =30A, $V_{GS}$ =10V <sup>(Note2)</sup>	-	99	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	VGS-10V	-	148	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =40A	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 40A	-	87.9	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note2)}$	-	129	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

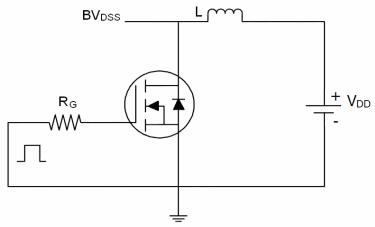
### Notes:

- 1. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 2. Pulse Test: Pulse Width  $\leq$  400 $\mu$ s, Duty Cycle  $\leq$  2%.
- 3. EAS condition: Tj=25  $^{\circ}\text{C}$  ,VDD=42.5V,VG=10V,L=1mH,Rg=25 $\Omega$
- 4. Isd $\leqslant$ 125A, di/dt $\leqslant$ 260A/ $\mu$ s, Vdd $\leqslant$ V(BR)dss, TJ  $\leqslant$ 175°C

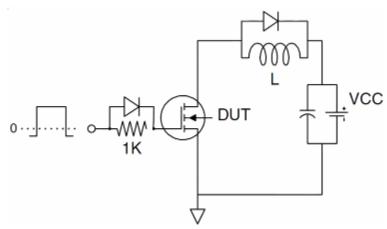
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## **Test Circuit**

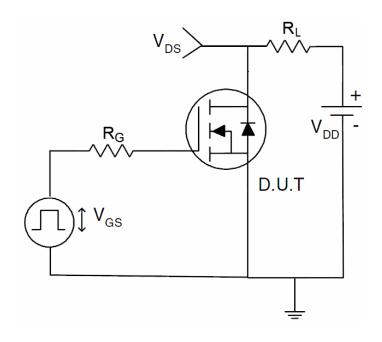
# 1) E<sub>AS</sub> test circuit



# 2) Gate charge test circuit

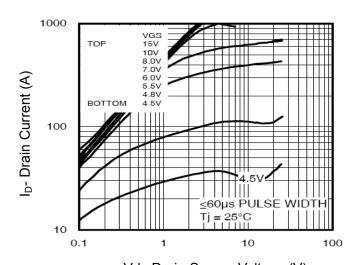


## 3) Switch time test circuit

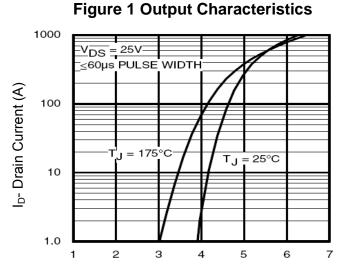




## **Typical Electrical and Thermal Characteristics**



Vds Drain-Source Voltage (V)



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

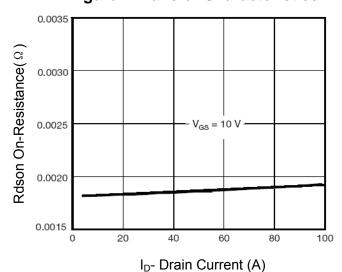
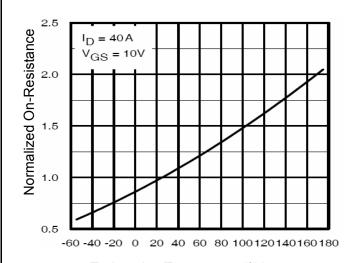


Figure 3 Rdson- Drain Current



T<sub>J</sub>-Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature

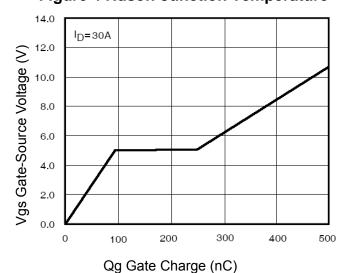


Figure 5 Gate Charge

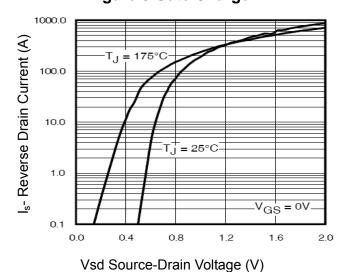


Figure 6 Source- Drain Diode Forward



C Capacitance (pF)

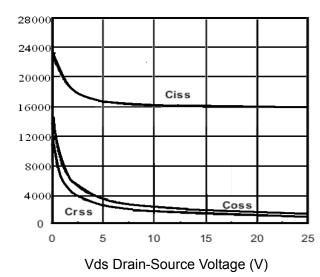


Figure 7 Capacitance vs Vds

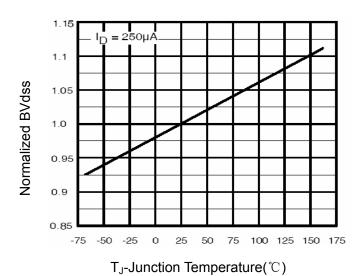


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

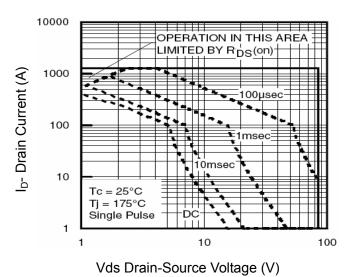


Figure 8 Safe Operation Area

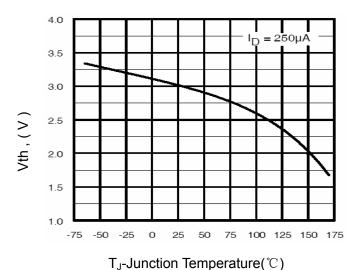
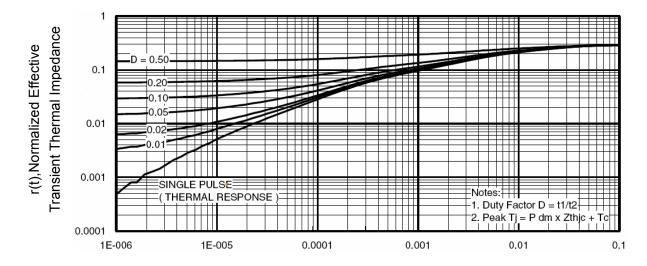


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

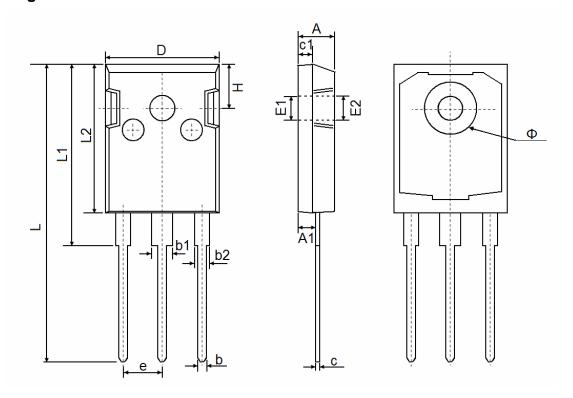


Square Wave Pluse Duration(sec)

**Figure 11 Normalized Maximum Transient Thermal Impedance** 



# **TO-247 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
А	4.850	5.150	0.191	0.200		
A1	2.200	2.600	0.087	0.102		
b	1.000	1.400	0.039	0.055		
b1	2.800	3.200	0.110	0.126		
b2	1.800	2.200	0.071	0.087		
С	0.500	0.700	0.020	0.028		
c1	1.900	2.100	0.075	0.083		
D	15.450	15.750	0.608	0.620		
E1	3.50	0 REF	0.138 REF			
E2	3.60	O REF 0.142 REF		3.600 REF		REF
L	40.900	41.300	1.610	1.626		
L1	24.800	25.100	0.976	0.988		
L2	20.300	20.600	0.799	0.811		
Ф	7.100	7.300	0.280	0.287		
е	5.45	5.450 TYP		0.215 TYP		
Н	5.98	30 REF 0.235 REF				

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